



Mechanical Data

Case: X3-DFN0603-2

D5V0L1B2LP3

LOW CAPACITANCE BIDIRECTIONAL TVS DIODE

Case Material: Molded Plastic, "Green" Molding Compound.

Terminals: Finish - Matte Tin over Copper Leadframe.

UL Flammability Classification Rating 94V-0

Moisture Sensitivity: Level 1 per J-STD-020

Weight: 0.0002 grams (Approximate)

Solderable per MIL-STD-202, Method 208 @3

Features

- Ultra-Small, Low Profile Leadless Surface Mount Package (0.6mm x 0.3mm x 0.3mm)
- Provides ESD Protection per IEC 61000-4-2 Standard: Air – ±30kV, Contact – ±30kV
- One Channel of ESD Protection
- Low Channel Input Capacitance
- Typically Used in Cellular Handsets, Portable Electronics, Communication Systems, Computers and Peripherals
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>



Top View

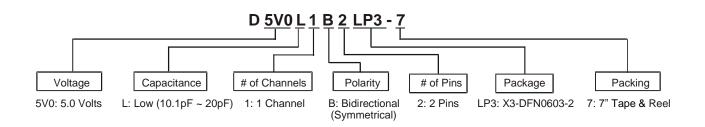


Bottom View



Device Schematic

Ordering Information (Note 4)



Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity Per Reel
D5V0L1B2LP3-7	Standard	Ν	7	8	10,000/Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

X3-DFN0603-2



N = Product Type Marking Code



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	Ppp	84	W	8/20µs, Per Fig. 1
Peak Pulse Current	IPP	6	А	8/20µs, Per Fig. 1
ESD Protection – Contact Discharge	Vesd_contact	±30	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V_{ESD} Air	±30	kV	Standard IEC 61000-4-2

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	PD	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	Reja	500	°C/W
Operating and Storage Temperature Range	Tj, Tstg	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

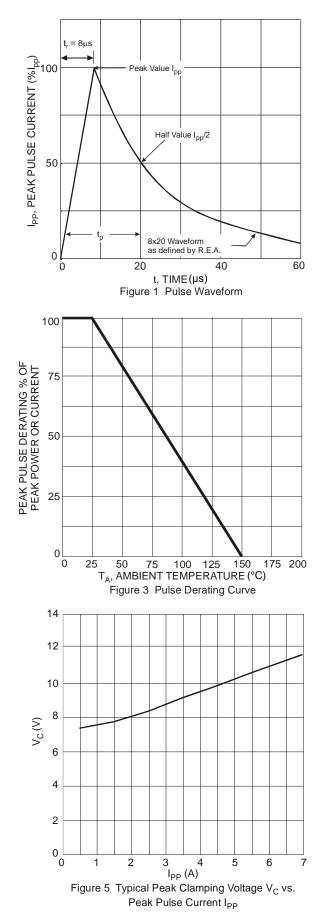
Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	Vrwm		_	5	V	—
Channel Leakage Current (Note 6)	IRM	_	10	100	nA	V _{RWM} = 5V
		_	7.0	9.0	V	$I_{PP} = 1A$, tp = 8/20µs, Figure 1
		_	8.7	10.7		IPP = 3A, tp = 8/20µs, Figure 1
Clamping Voltage, Positive Transients	Vcl	_	10.5	12.0		$I_{PP} = 5A$, tp = 8/20µs, Figure 1
		_	11.5	14.0		$I_{PP} = 6A$, tp = 8/20µs, Figure 1
Breakdown Voltage	V _{BR}	6	7	8	V	I _R = 1mA
Differential Resistance	R _{DIF}	_	0.2	_	Ω	$I_R = 1A$, tp = 8/20µs
ESD Clamping Voltage (Note 7)	N	_	9.6	_	V	IPP = 4A, tp = 10/100ns
	Vc	_	16.0	_		IPP = 16A, tp = 10/100ns
Channel Innut Conceitence		—	15	18	рF	$V_R = 0V, f = 1MHz$
Channel Input Capacitance	Ст	_	12.5	—		V _R = 2.5V, f = 1MHz

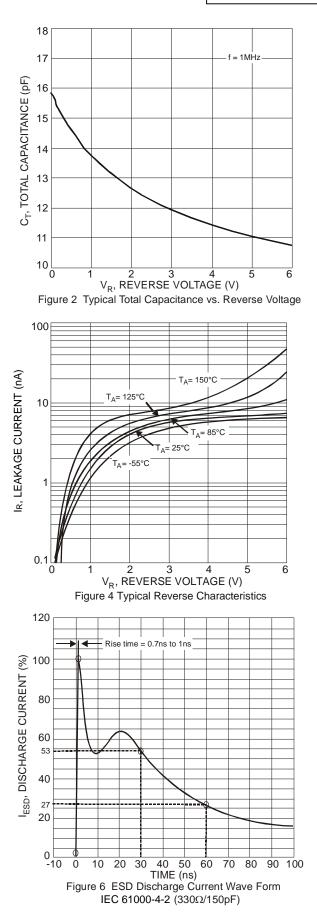
Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.

6. Short duration pulse test used to minimize self-heating effect.

7. Transmission Line Pulse Test (TLP) settings: tp=100ns, tr=10ns, ITLP and VTLP averaging window is from 70ns to 90ns.

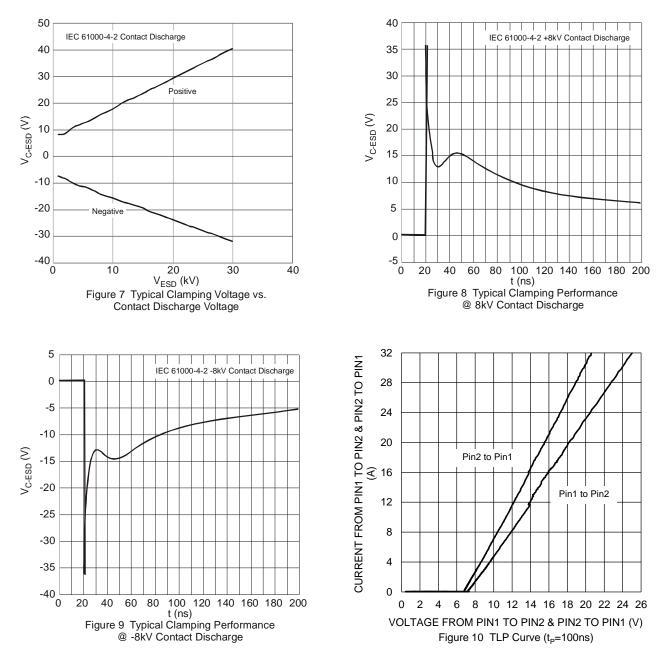








D5V0L1B2LP3

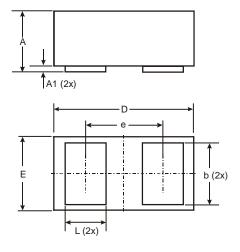




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

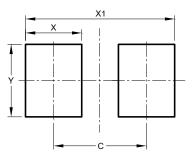
X3-DFN0603-2



X3-DFN0603-2						
Dim	Min	Max	Тур			
Α	0.27	0.35	0.30			
A1	0.00	0.03	0.02			
b	0.19	0.29	0.24			
D	0.595	0.645	0.62			
E	0.295	0.345	0.32			
е	-	-	0.355			
L	0.14	0.24	0.19			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value		
Dimensions	(in mm)		
С	0.380		
Х	0.230		
X1	0.610		
Y	0.300		

X3-DFN0603-2



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